IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

STATEMENT UNDER 37 CFR 3.73(b)

Faus Oroup, Inc., states that it is the assignee of the entire right, title, and interest of the U.S. applications/patents identified in the attached Appendix A. An assignment form the inventors of the patent application/patent identified in the Appendix A.

Please change the correspondence address for all of the patents identified in Appendix A to the address associated with:

Customer Number: 88944

The assignee of record of the entire right, title, and interest of the patents identified in Appendix A, in accordance with 37 C.F.R. § 3.73(b), is Faus Group, Inc., organized and existing under the laws of the state of Georgia, having a usual place of business at 10 Marine Drive, Calboun, Georgia 30701.

SIGNATURE OF ASSIGNEE OF RECORD

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

Name:	Mr. Gonzalo Frey Pazos
Title:	CEO at Fau Group Inc.
Signature	
Date	1 129-08-11 Telephone No.

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	STATUS	Pending	Pending	Pending	Pending	Pending	Pending	Pending	Pending	Pending	Pending	Pending	Pending
APPENDIX A	FILING/ISSUE DATE	04-13-2010	11-19-2010	11-19-2010	02-27-2003	01-16-2004	11-05-2004	11-05-2004	09-19-2007	10-04-2005	01-28-2003	10-21-2003	02-28-2005
	APPLN./PAT. NO.	12/759,600	12/950,900	12/950,895	10/374,751	10/758,001	10/981,759	10/981,756	11/902,200	11/242,145	10/352,189	10/689,510	11/066,101
	TITLE	MOLDING PROFILE AND MOLDING PROFILE ASSEMBLY	FLOORING SYSTEM HAVING MICROBEVELS	FLOORING SYSTEM HAVING COMPLEMENTARY SUB- PANELS	FLOORING SYSTEM HAVING COMPLEMENTARY SUB- PANELS	DIRECT LAMINATED FLOOR	FLOORING SYSTEM HAVING MULTIPLE ALIGNMENT POINTS	FLOORING SYSTEM WITH SLANT PATTERN	MOLDING PROFILE AND MOLDING PROFILE ASSEMBLY	WALL TRANSITION MOLDING	EMBOSSED-IN-REGISTRATION FLOORING SYSTEM	FLOORING SYSTEM HAVING SUB-PANELS	FLOORING SYSTEM HAVING LARGE FLOOR PATTERN
	ATTORNEY DOCKET NO.	5724.092.10	5724.017.10	5724.017.25	5724.017.22	5724.012.21	5724.110.00	5724.109.00	5724.092.20	5724.133.00	5724.017.20	5724.017.23	5724.108.00

Pending	Pending	Granted	Granted	Granted	Granted	Granted
07-07-2004	01-11-2008	05-03-2002	01-28-2003	10-06-2003	07-13-2001	03-15-2004
10/885,230	12/007,582	6,691,480	7,836,648	7,836,649	6,638,387	7,287,357
5724.091.00 FLOORING SYSTEM HAVING SUB-PANELS WITH COMPLEMENTARY EDGE PATTERNS	PRECISION SURFACE TECHNOLOGY	5724.017.00 EMBOSSED IN-REGISTER PANEL SYSTEM	FLOORING SYSTEM HAVING COMPLEMENTARY SUB- PANELS	5724.017.24 FLOORING SYSTEM HAVING MICROBEVELS	5724.016.00 EMBOSSED-IN-REGISTER MANUFACTURING PROCESS	5724.092.00 MOLDING PROFILE AND MOLDING PROFILE ASSEMBLY
5724.091.00	5724.255.00	\$724.017.00	5724.017.21	5724.017.24	5724.016.00	5724.092.00